

A detailed micrograph of a Silicon Photomultiplier (SiPM) device. The image shows a complex network of gold-colored microstructures on a dark substrate. Three large, spherical, metallic-looking structures are prominent, connected by intricate wiring. A plus sign (+) is visible in the upper right area, and a small circle is in the lower right. The overall layout is highly symmetrical and precise.

Broadcom's SiPM technology

IFPD

November 2022



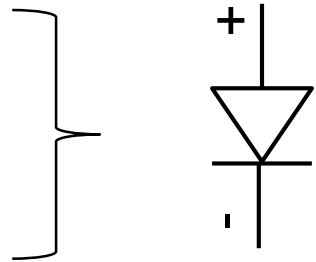
Photodiode – APD – SPAD/SiPM

- p-n junctions in semiconductors are the basis of

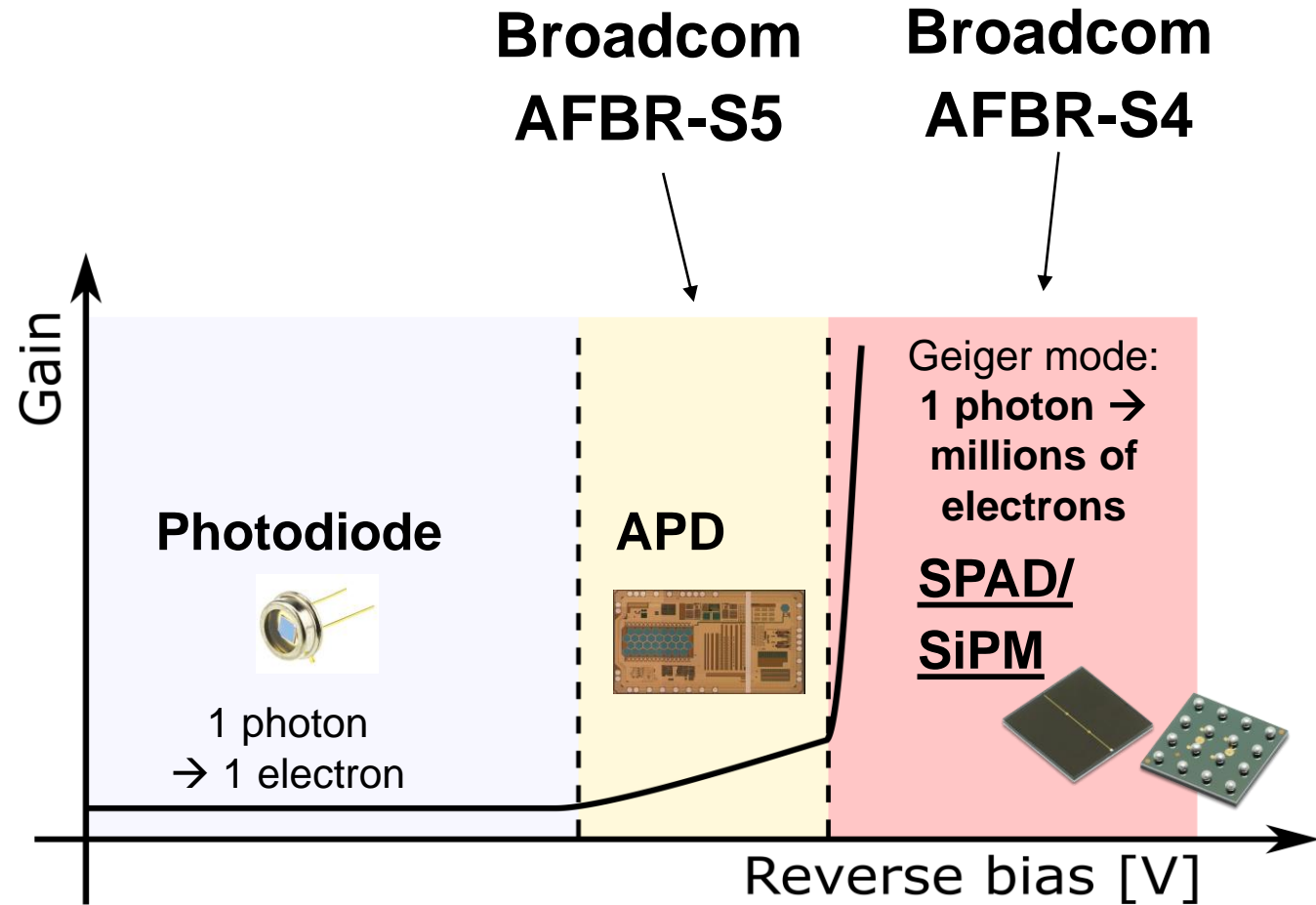
- Photodiodes

- APDs

- SPADs



- Can be differentiated by gain
- Gain can be driven by reverse bias
- Photodiode: no gain
- **APD:** Avalanche Photodiode, internal gain 10 to 100
- **SPAD:** single photon avalanche diode, internal gain few k up to 10M
- **SiPM:** is an array of SPADs



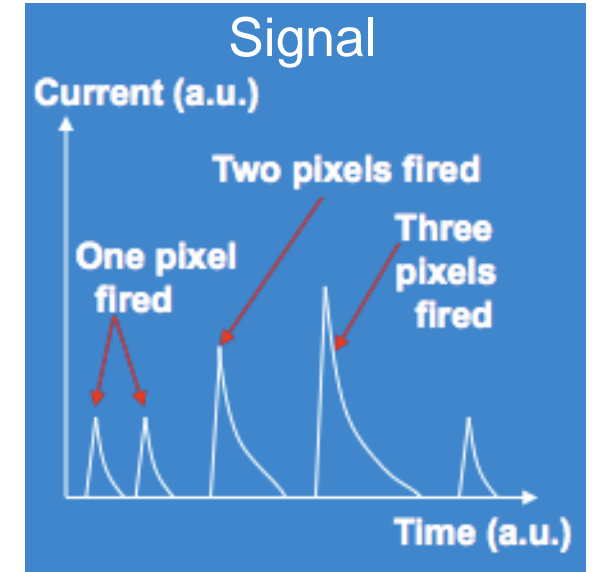
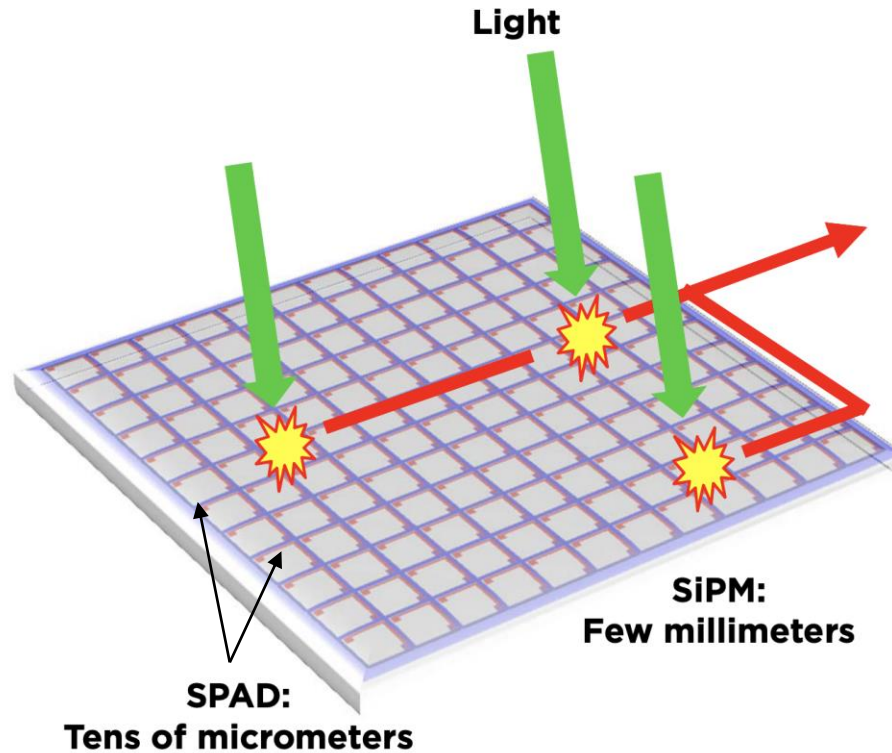
Silicon Photomultiplier (SiPM)

An SiPM is

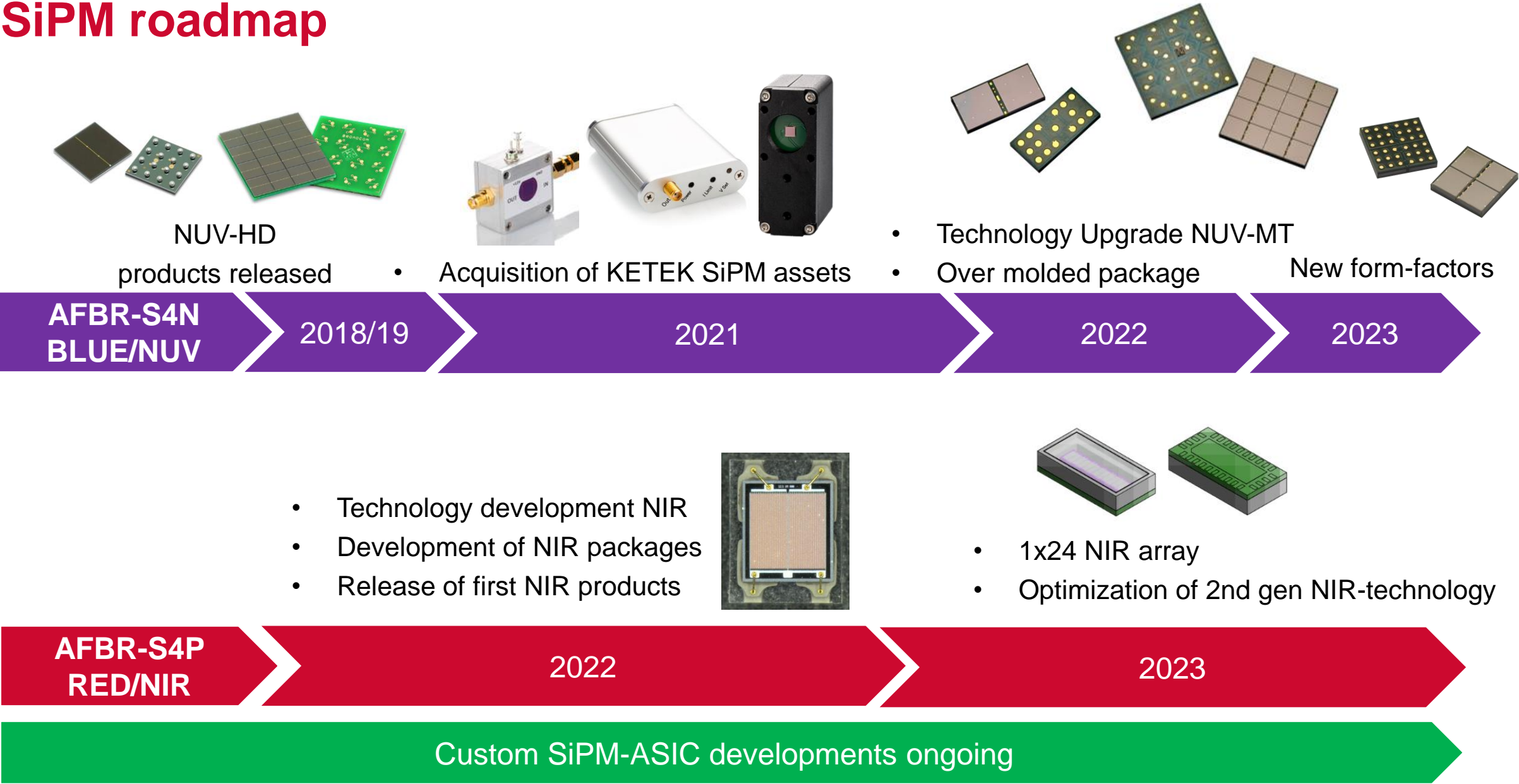
- an array of single photon avalanche diodes (SPADs)
- sensitive to single photons
- providing very high internal gain → quasi-digital states of SPADs (on/off)
- very fast

An SiPM is NOT

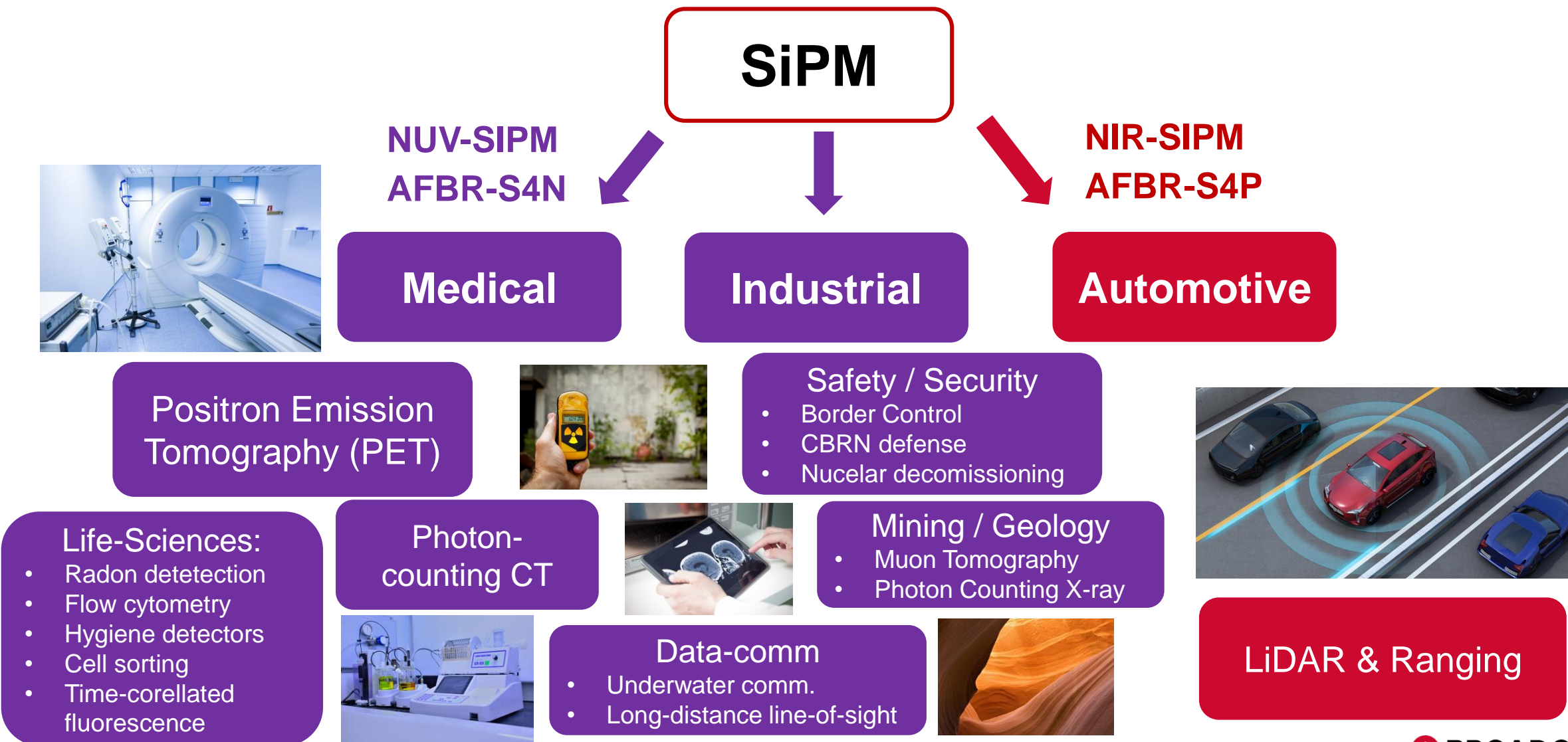
- an imaging/camera sensor!!!



SiPM roadmap



AFBR-S4 Silicon Photomultipliers: Applications



Integrated SiPM TIA modules

AFBR-S4KTIA3315B

- Features

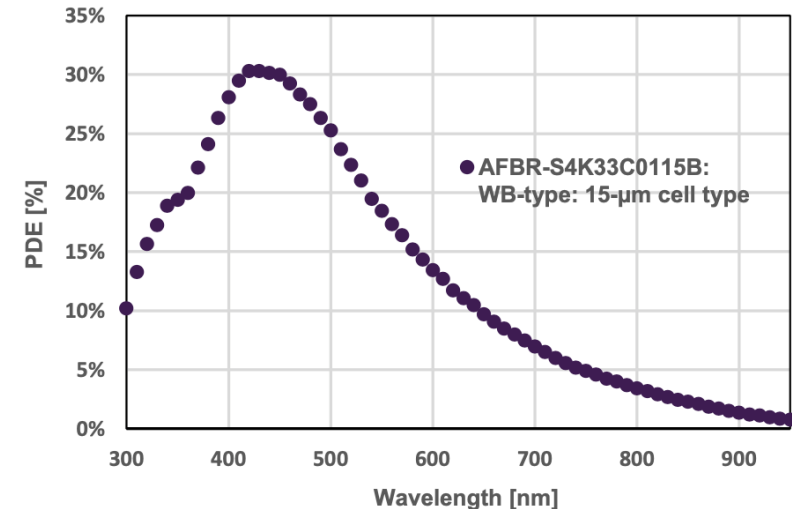
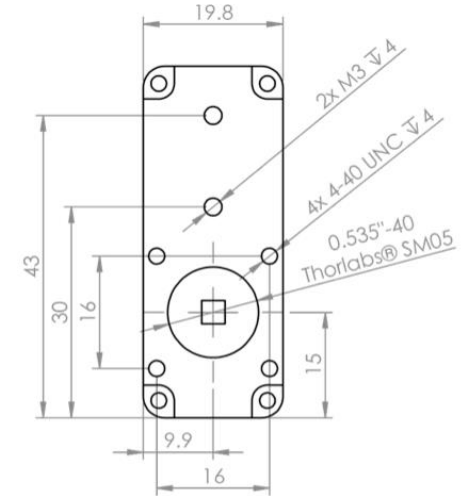
- Integrated TIA
- Integrated SiPM Bias Supply
- Adjustable gain
- Housing compatible with Thorlabs SM05 cage mount
- Housing compatible with standard PMT-modules

- Connections:

- Input 1: Bias 5V
- Input 2: Bias control 0 to 1V
- Output 1: Analog signal out (coax)

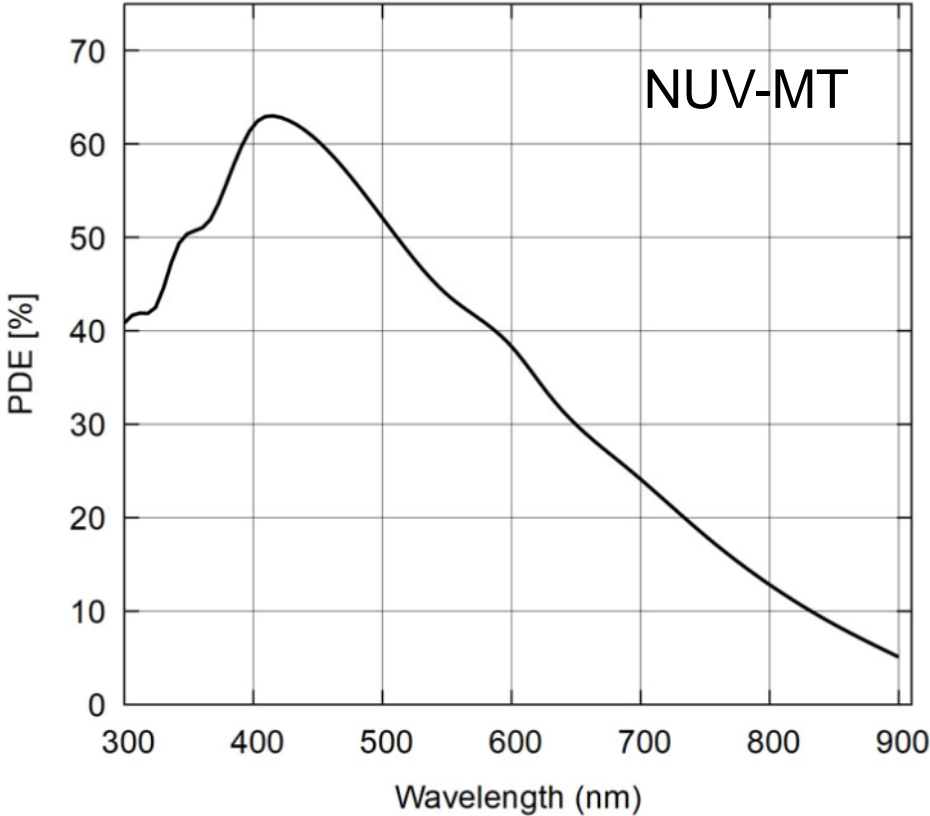
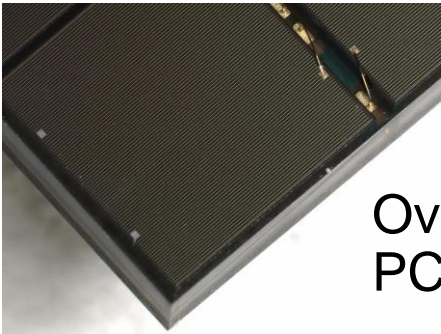
- Applications

- Flow Cytometry
- Life Sciences



AFBR-S4N: NUV-SiPM Technology

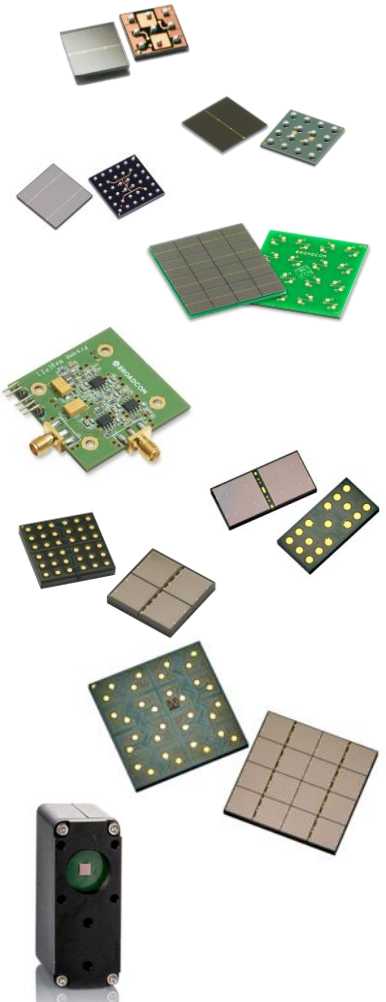
	NUV-HD	NUV-MT
Package	CSP	Overmolded PCB
Sensitivity range (nm)	250 to 900	250 to 900
Peak sensitivity (nm)	420	420
PDE at peak sensitivity (%)	54	63
Gain (M)	3.2	7.3
DCR (kcps/mm2)	270	120
SPAD pitch (μm)	30	40
CT (%)	34	23
AP (%)	1	1
Recharge time constant (ns)	50	55
Typ. OV	7	12
Vbreak (V)	26.9	32.5
Status	Productive	Productive



AFBR-S4N: NUV-SiPM Product Summary

Part no	Technology	Size (mm ²)	Channels	Package	Status
AFBR-S4N33C013	NUV-HD	3 x 3	1	CSP	Productive
AFBR-S4N44C013	NUV-HD	4 x 4	1	CSP	Productive
AFBR-S4N66C013	NUV-HD	6 x 6	1	CSP	Productive
AFBR-S4N44P163	NUV-HD	16 x 16	4 x 4	CSP	Productive
AFBR-S4E001	NUV-HD	4 x 4	1	Eval-Kit	Productive
AFBR-S4N66P024M	NUV-MT	13 x 6	2 x 1	Overmolded PCB	Productive
AFBR-S4N44P044M	NUV-MT	8 x 8	2 x 2	Overmolded PCB	E-samples
AFBR-S4N44P164M	NUV-MT	16 x 16	4 x 4	Overmolded PCB	Productive
AFBR-S4N44P014M	NUV-MT	4 x 4	1	Overmolded PCB	E-samples
AFBR-S4N66P014M	NUV-MT	6 x 6	1	Overmolded PCB	E-samples
AFBR-S4KTIA3315B	NUV-B*	3 x 3	1	TIA-module	Productive

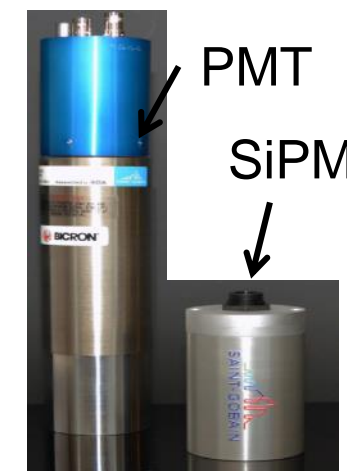
*upgrade to NUV-MT planned



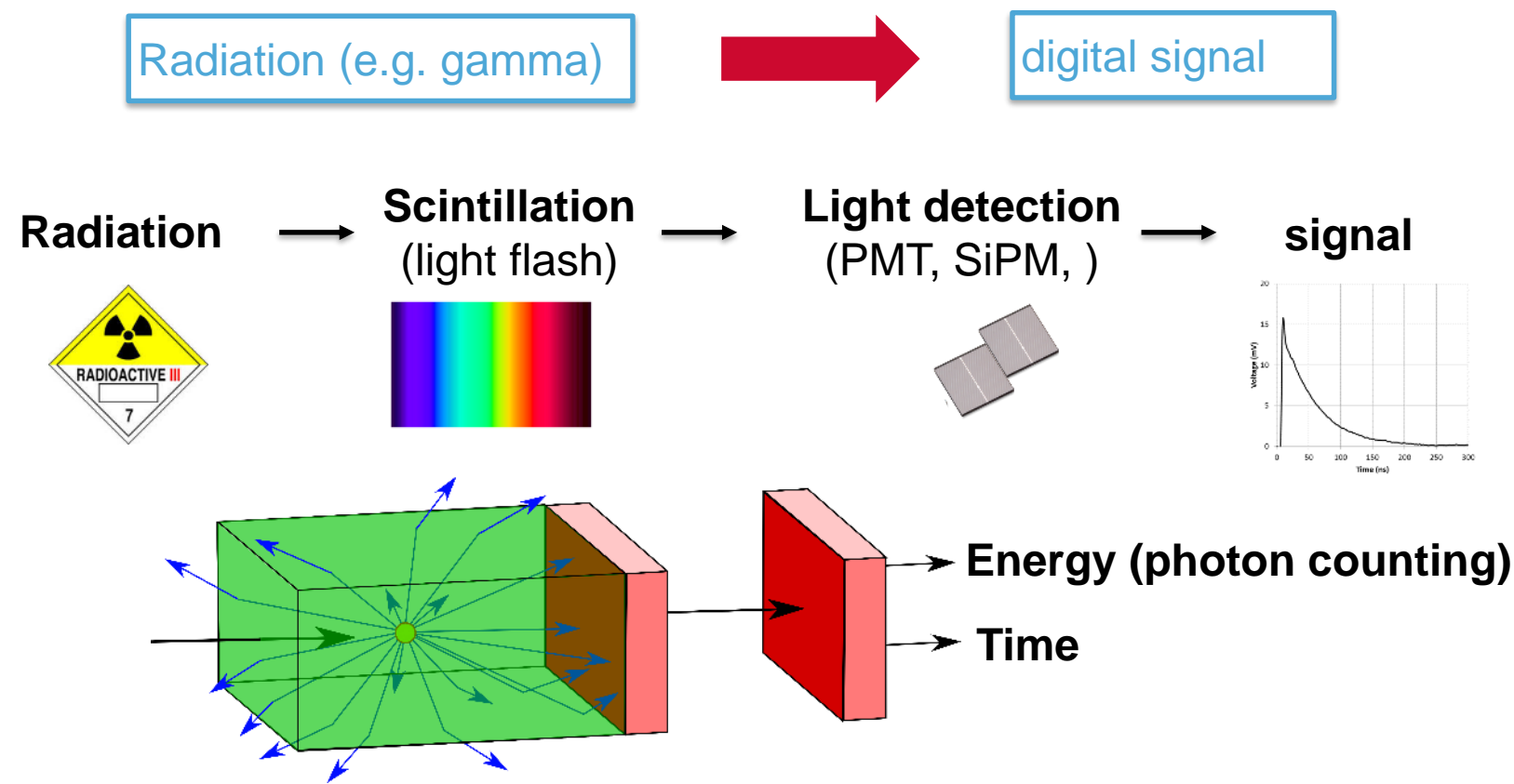
Application Focus: Safety & Security

- Task: detect radiation or high energy X-rays using scintillators and SiPM (scintillators convert radiation to visible light, SiPM detects visible light!)
- Requirements for photodetector in Security Applications:
 - High speed & High sensitivity
- Special advantages of SiPM for Hand-Held devices:
 - **Robust**
 - **Low voltage**
 - **Can be battery powered**
 - **Insensitive to magnetic fields**
- Keywords to watch for:
Chemical Biological Radiological and Nuclear (CBRN) defense, EHS, portal monitor, cargo screening, scintillation, radiation detection, radiation safety, border control, nuclear instrumentation/ decommissioning /decontamination, dosimetry

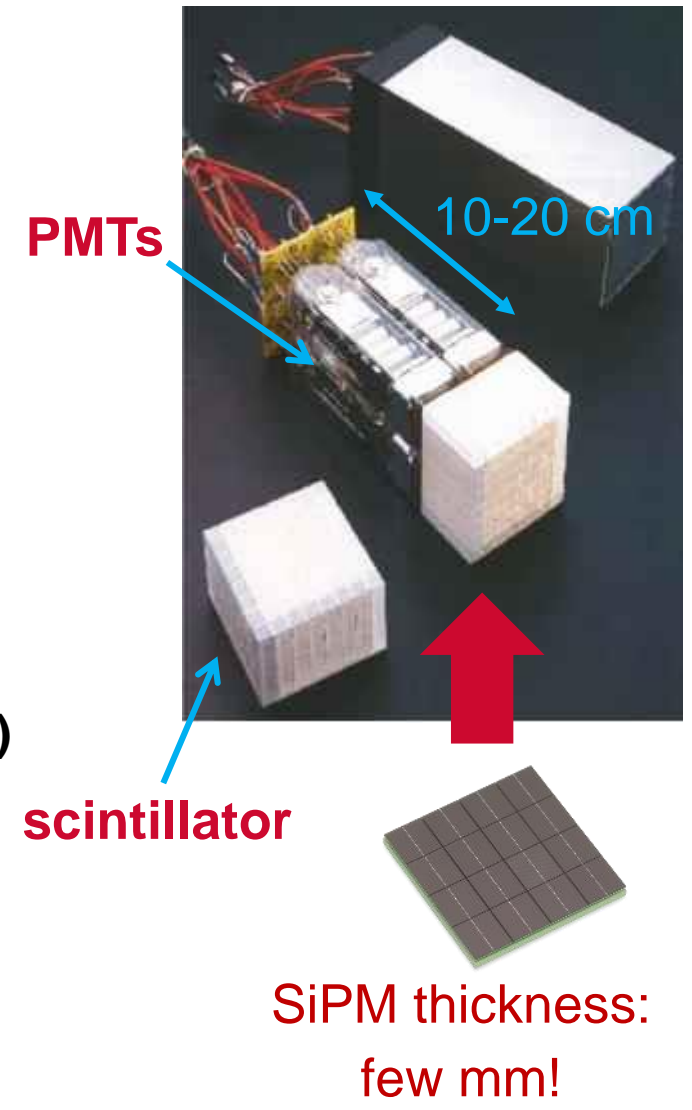
PMTs are still state-of-the-art, but SiPMs will replace PMTs, because SiPMs are much smaller, less expensive, more robust and require a much lower operating voltage.



Radiation detection with SiPMs



SiPMs are perfectly suited to detect scintillation light!



Roadmap for NIR SiPMs for Broadcom IFPD

NUV-HD

Medical / PET



Safety & Security



NIR

Automotive Lidar



Industrial / Robotics



2018

2023

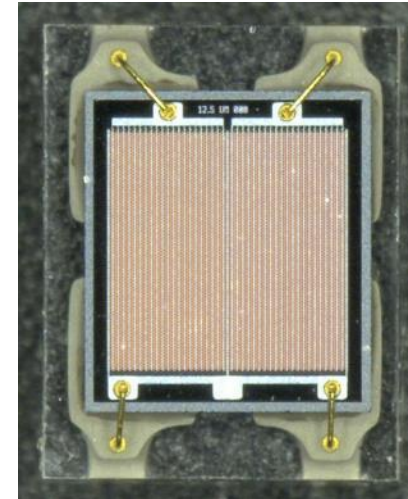
NIR vs. longer wavelength in LiDAR systems

- NIR LiDAR at 905 nm wavelength enables
 - Lower laser and receiver cost
 - Higher robustness of silicon detector
 - Lower power consumption
 - Better scalability for high volume
- NIR LiDAR at 905 nm limitation
 - Lower emitted optical power to meet eye safety
 - High PDE receivers required
- NIR is ideal for high volume LiDAR enabling high performance industrial robotics and automotive ADAS.



Broadcom's NIR30 SiPM Technology Advantages

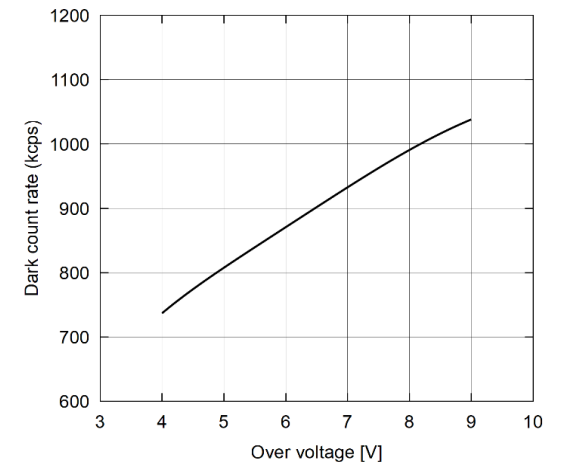
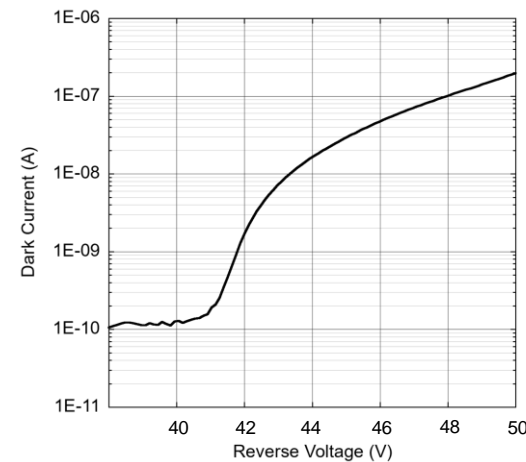
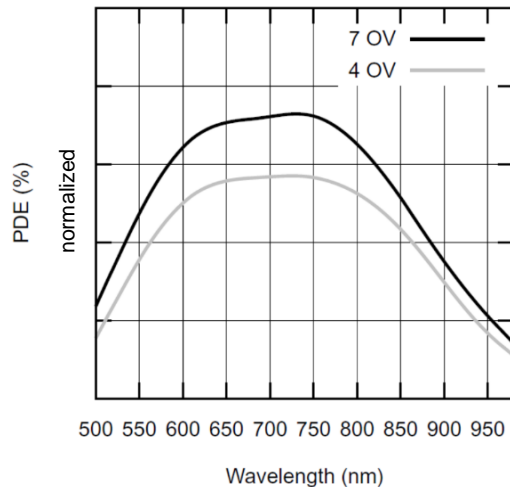
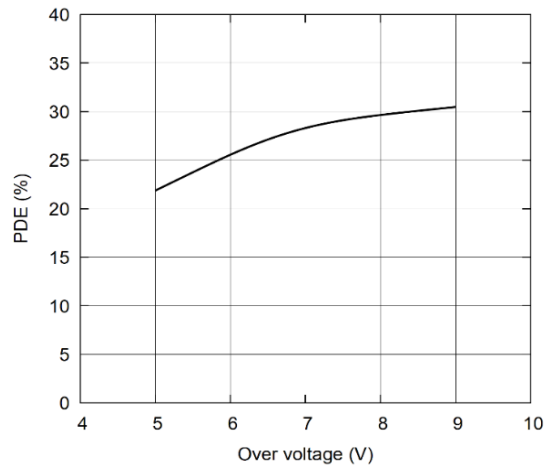
- Completely new SPAD structure optimized for LiDAR application
 - PDE at 905 nm: ~30%
 - High dynamic range: > 6000 SPADs / 1 mm²
 - Recharge time constant (DC out): < 20 ns
 - Optical cross talk: < 5 %
 - Bias voltage: < 60 V
- Engineering samples available
 - Dual Channel: 1 x 1 mm² active area
 - 1x24 Channel Array: 5.6 x 1.1 mm² active area
- Development of custom detectors also with smaller channel size possible



Next Technology Generation NIR30

- Higher PDE: about 30% @905 nm
- Low direct cross talk: less than 5%
- Reduced after pulsing and long tail noise

Graphs are exemplary, final performance is under evaluation



➤ Engineering samples available

SiPM NIR30 1x2 Channels for Industrial Market

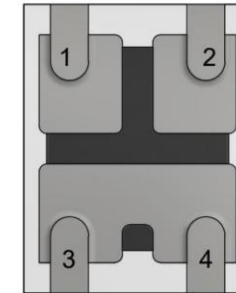
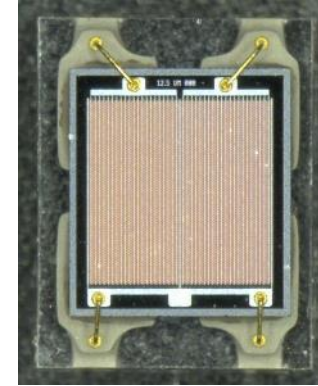
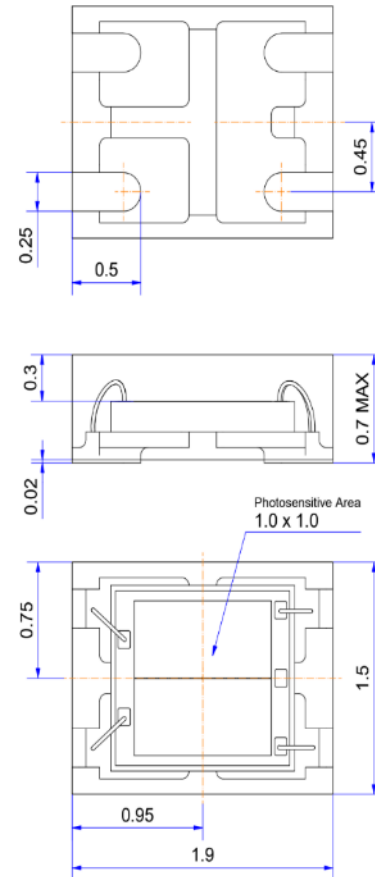
AFBR-S4P11P012R

Features

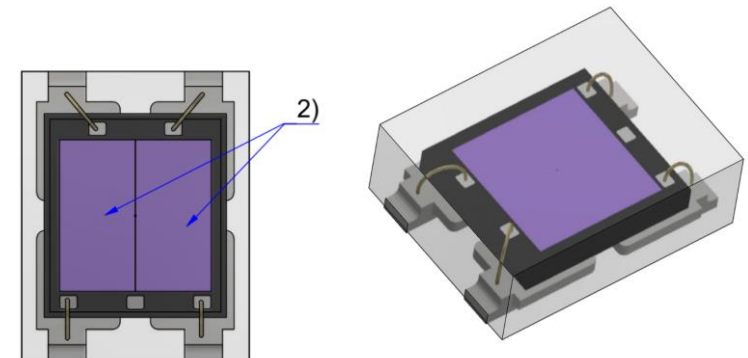
- Active area 1 x 1 mm² (can be split in 1x2 array)
- PDE higher than 30% at $\lambda=905$ nm
- Wide dynamic range
- Very fast cell recharge time constant (< 15 ns)
- Low bias voltage (< 60 V)
- Compact moulded lead frame package
- Operating temperature range from -40 to +85 °C

Engineering Samples available

Product Release end Q2 CY23



Pin Assignment	
Pin #	Description
1	Cathode 1
2	Cathode 2
3	Anode
4	Anode



SiPM NIR30 1x24 Array Package Dimensions

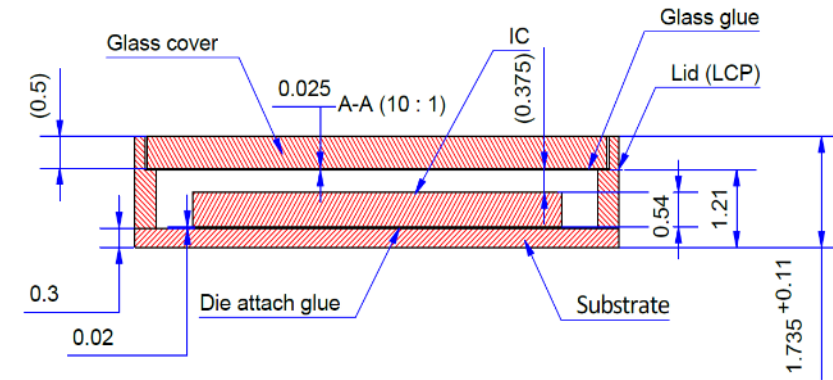
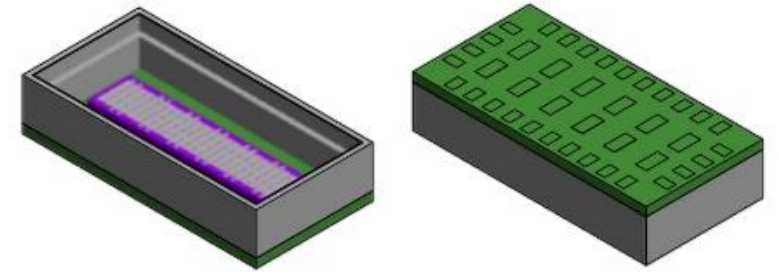
AFBR-S4P0124P2RA

Features

- 1x24 Channel Array with $\sim 0.25 \times 1.1 \text{ mm}^2$ active area per channel
- Broadcom NIR30 SiPM Process
- 28-pin 8 x 4 mm² optical quad flat no leads package (OQFN)
- AR Coated cover glass (optimized for 905 nm range)
- AEC-Q102 qualified
- -40 to 105 °C ambient temperature range
- IATF 16949 certified production line

Engineering samples available

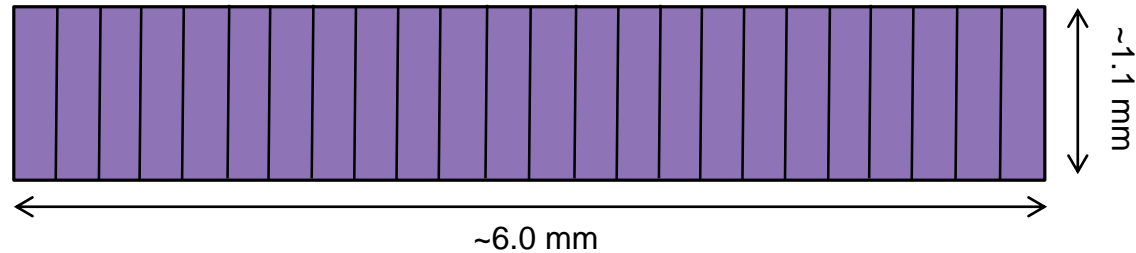
SOP Q3 CY23



Package cross section

SiPM NIR20 1x24 Array for High Resolution Scanner Application

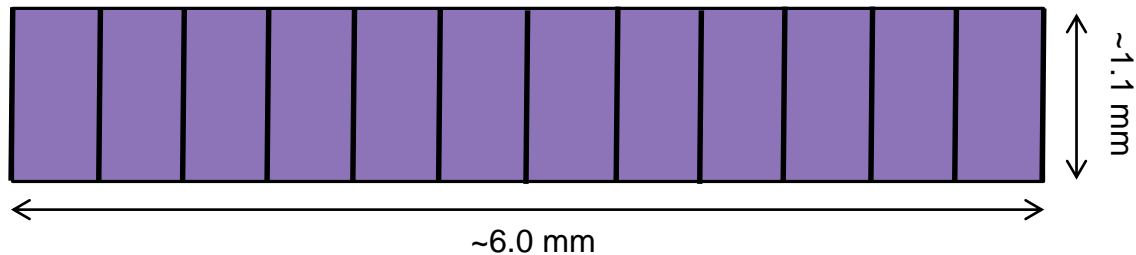
1x24



- channel $\sim 0.25 \times 1.1 \text{ mm}^2$
- $\sim 1:4$ aspect ratio
- $12.5 \mu\text{m}$ SPAD pitch
- ~ 1600 SPADs / channel

- Adjacent channels can get connected on customer PCB to mimic 1x12 arrays:

1x12



- channel $\sim 0.5 \times 1.1 \text{ mm}^2$
- $\sim 1:2$ aspect ratio
- $12.5 \mu\text{m}$ SPAD pitch
- ~ 3200 SPADs / channel